

TF

D-Sub connectors - Stamped and Formed Contacts

PRESS FIT STRAIGHT PCB TERMINATION



CHARACTERISTICS

Materials and Platings	
Shells	Steel, tin plated
Insulator	Glass-filled thermoplastic, UL 94V-0
Pin contact	Brass, selected gold in mating area; 2.54µm (100µ") min. tin on termination area over 1.27µm (50µ") min. nickel
Socket contact	Phosphor bronze, selected gold in mating area; 2.54µm (100µ") min. tin on termination area over; 1.27µm(50µ") min. nickel
Rear insert	Brass, 2.54µm (100µ") min. nickel plated
Boardlock	Brass, 2.54µm (100µ") min. nickel plated
Screwlock	Brass, 2.54µm (100µ") min. nickel plated

Electrical Data	
Current rating	3A
Voltage rating	300V AC
Withstanding voltage	1000V AC/rms 60Hz for one minute
Insulation resistance	1000MΩ
Contact resistance	25mΩ max

Climatic Data	
Operating temperature	-55°C to +125°C
Salt spray	24 hours

Mechanical Data	
Single contact insertion force	≤ 3.60 N
Single contact withdrawal force	≥ 0.2 N
Single contact insertion on board	≤ 100 N
Single contact withdrawal from board	≥ 20 N
Standard plating thickness	Gold flash 0.4µm (15µ") gold 0.76µm (30µ") gold

	Terminal Specification	Boardlock Specification
Finished Hole	1 (+0.09 -0.06)	3.1 +/- 0.05 mm
Cu	> 25 µm	Min 25 µm
Sn	< 15 µm	5-15 µm

DESCRIPTION

The Amphenol "TF" series features eye of needle formed contacts, and insulator with closed entry contacts cavities.

This series gives you Amphenol's high standards of quality and reliability to meet all your technical requirements.

*Solderless
straight PCB
mount
connectors*

APPLICATIONS

- Industrial
- Telecom
- Any backplanes connections



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